Related Information

Ultra High-speed High-precision Laser Displacement Sensor HL-C2 SERIES

General terms and conditions...... F-17

Glossary of terms / General precautions P.1397 / P.1405

LASER SENSORS PHOTOELECTRIC SENSORS MICRO PHOTOELECTRIC SENSORS AREA SENSORS LIGHT CURTAINS PRESSURE / FLOW SENSORS INDUCTIVE PROXIMITY SENSORS PARTICULAR USE SENSORS SENSOR OPTIONS

OPTIONS SIMPLE WIRE-SAVING UNITS WIRE-SAVING SYSTEMS

MEASUREMEN SENSOR

STATIC CONTROL DEVICES ENDOSCOPE LASER MARKERS PLC / TERMINALS HUMAN MACHINE INTERFACES ENERGY CONSUMPTION VISUALZATION COMPONENTS FA COMPONENTS MACHINE VISION SYSTEMS

UV CURING SYSTEMS



HL-G1
HL-C2
HL-C1
LM10

0.0004 mil <u>High-reso</u> HDLC-CMOS sensors The HDLC-CMOS sensors have been developed specially for the HL-C2

series. High density light-receiving cells and a processing speed which is close to maximum limits result in high resolutions and high speeds which exceed all expectations for laser displacement sensors.

HDLC: High Density Linear Cell

Comparison of cell structures (Image)

Previous

HL-C2



Sensor selection guide P.967~

About laser beam......P.1403~





HL-C2 series are introduced to limited countries only, because some models falls under WA (Wassenaar Arrangement) 2.B.6.b.1.a, and NSG (Nuclear Suppliers Group) guidelines 1.B.3.b.1. Please contact our office for details.



This product is classified as a Class 1 / Class 2 / Class 3R Laser Product in IEC / JIS standards and a Class I / Class II / Class IIIa Laser Product in FDA regulations 21 CFR 1040.10. Never look at or touch the direct laser beam and its reflection.

Ultra-high speed calculation processor

HL-C203F

Ultra high-speed, high-precision laser displacement sensors using a combination of new technology

panasonic-electric-works.net/sunx

Excellent basic performance

These sensors achieve an excellent level of performance in the three basic functions which are required of reflective type laser displacement sensors. They can provide "Surplus", "Reliability" and "Confidence" to production sites which demand high speeds and high precision.



MSGB



Resolution Sampling

982

USE SENSORS

SIMPLE WIRE-SAVING UNITS

WIRE-SAVING

STATIC CONTROL DEVICES

ENDOSCOPE

LASER MARKERS

PLC / TERMINALS

HUMAN MACHINE INTERFACES

ENERGY CONSUMPTION VISUALIZATION COMPONENTS

FA COMPONENTS

MACHINE VISION

UV CURING SYSTEMS

SYSTEMS

Selection Guide

Collimated Beam

Digital Panel Controller Metal-sheet Double-feed Detection

Laser Displa Magnetic Displacement

SYSTEMS MEASUREMENT SENSORS

SENSOR OPTIONS



High-resolution lens

MSGB

High-resolution lens has been newly designed to perfectly suit HDLC-CMOS sensors. The light-receiving part can create images at a minimum point from light received from a variety of different angles to produce images with even greater precision.



Exclusive optical equipment and diaphragm structure

sustain laser beam of high quality at a radiant density

Emission intensity adjustment function, using the newest algorithm, is able to follow any deviation of the light receiving intensity instantaneously maintaining the best

that is close to ideal in the Gaussian distribution.

emitting condition at all times.

MSGB: Micro Spot Gaussian Beam



Image

Resolution Linearity

Comparison of beam diameter

HL-C2 Previous 30 µm

Image

Sampling

HL-G1	
HL-C2	
HL-C1	
LM10	

Ultra high-speed calculation processor

All signals are digitalized by a high speed processor while achieving high precision and high speed with its exclusive algorithm.

Resolution Linearity

FIBER SENSORS LASER SENSORS

PHOTOELECTRIC

SENSORS

MICRO PHOTOELECTRIC

SENSORS

AREA SENSORS

LIGHT CURTAINS

PRESSURE /

FLOW SENSORS INDUCTIVE PROXIMITY

SENSORS

PARTICULAR

SENSOR

WIRE-SAVING UNITS

WIRE-SAVING

MEASUREME SENSOR

STATIC CONTROL

ENDOSCOPE

PLC / TERMINALS

HUMAN MACHINE INTERFACES

ENERGY CONSUMPTION VISUALIZATION

FA COMPONENTS

MACHINE VISION SYSTEMS

UV CURING SYSTEMS

COMPONENTS

DEVICES

LASER MARKERS

SYSTEMS

SIMPLE

USE SENSORS

SYSTEM LAYOUT





Console



Easy to operate using the touch panel and simple display.





Not only measurement values, but also the wavelength of the amount of light received can be displayed.

Intelligent Monitor

Waveform monitoring and function setting by computer at great convenience





Light receiving intensity in waveform display

Buffering display

ORDER GUIDE

Sensor heads							LASER
Туре	Appearance	Measurement center distance and measuring range	Resolution	Beam size	Model No.	Laser class	PHOTO- ELECTRIC SENSORS
			0.01 µm 0.0004 mil	ø20 μm	HL-C201F		MICRO PHOTO- ELECTRIC
Small beam spot type		10 ±1 mm	0.25 μm 0.010 mil	ø0.787 mil approx.	HL-C201FE	FDA: Class I	AREA
	LASER SEMON ML-C2 ONVINS	0.394 ±0.039 in	0.01 µm 0.0004 mil	20 × 700 µm	HL-C201F-MK	IEC: Class 1	
Linear beam spot type			0.25 µm 0.010 mil	0.787 × 27.559 mil approx.	HL-C201FE-MK		CURTAINS
Small beam spot type			0.025 µm 0.001 mil	ø30 μm ø1.181 mil approx.	HL-C203F	FDA: Class II IEC: Class 2	FLOW SENSORS
	N C PL OCTATION	30 ±5 mm 1.181 ±0.197 in	0.25 µm 0.010 mil		HL-C203FE		INDUCTIVE PROXIMITY SENSORS
Linear beam spot type			0.025 µm 0.001 mil	30 × 1,200 μm 1.181 × 47.244 mil approx.	HL-C203F-MK		PARTICULAR
			0.25 μm 0.010 mil		HL-C203FE-MK		SENSORS
			0.1 µm 0.004 mil	ø80 μm ø3.150 mil approx.	HL-C211F	FDA: Class II IEC: Class 2 FDA: Class IIIa IEC: Class 3R	OPTIONS
			0.25 µm 0.010 mil		HL-C211FE		SIMPLE WIRE-SAVING UNITS
Small beam spot type			0.1 µm 0.004 mil		HL-C211F5		WIRE-SAVING SYSTEMS
		110 +15 mm	0.25 µm 0.010 mil		HL-C211F5E		MEASURE-
	A A A A A A A A A A A A A A A A A A A	4.331 ±0.591 in	0.1 µm 0.004 mil	80 × 1,700 μm 3.150 × 66.929 mil approx.	HL-C211F-MK	FDA: Class II IEC: Class 2	SENSORS
			0.25 µm		HL-C211FE-MK		CONTROL DEVICES
Linear beam spot type			0.1 µm 0.004 mil		HL-C211F5-MK	EDA: Class IIIa	ENDOSCOPE
			0.25 µm 0.010 mil		HL-C211F5E-MK	IEC: Class 3R	LASER MARKERS

Controllers

	Туре	Appearance	Model No.	Applicable sensor head
solution	NPN output		HL-C2C	HL-C201F(-MK) HL-C203F(-MK)
High-re	PNP output		HL-C2C-P	HL-C211F(-MK) HL-C211F5(-MK)
NPN Indrino PNF Indrino	NPN output		HL-C2CE	HL-C201FE(-MK) HL-C203FE(-MK)
	PNP output	Anter service HL-22 service	HL-C2CE-P	HL-C211FE(-MK) HL-C211F5E(-MK)

Compact consoles

Туре	Appearance	Model No.	HUMAN MACHINE INTERFACES
51			ENERGY CONSUMPTION
English display	~	HL-C2DP-EX	VISUALIZATION COMPONENTS
	mus min min *		FA
Japanese display		HL-C2DP	COMPONENTS
Chinese display		HL-C2DP-CH	MACHINE VISION SYSTEMS
Korean display		HL-C2DP-KR	UV
		1	ÓUDINO

PLC / TERMINALS

Options

Designation	Appearance	Model No.	Description				
Intelligent monitor	Indiger Monier H.(-2.0.M) Mana Mana Mana Mana Mana Mana Mana Ma	HL-C2AiM	Enables the waveform display of each measurement condition setting and of measurement values as well as monitoring of measurement data and received light intensity data.				
ND filter		HL-C2F01	When the amount of reflected light is large at the time that a specular reflective sensor is installed, reducing the amount of laser light to an appropriate level enables a higher precision measurement. (Light detection rate: 98 %)				
		HL-C2CCJ2	Length: 2 m 6.562 ft, Weight: 0.2 kg approx.		LM10		
Sensor head extension cable		HL-C2CCJ5	Length: 5 m 16.404 ft, Weight: 0.4 kg approx.	Cabtyre cable with connector on both			
		HL-C2CCJ10	Length: 10 m 32.808 ft, Weight: 0.7 kg approx.	Cable outer diameter: ø6.6 mm ø0.260 in			
			HL-C2CCJ20	Length: 20 m 65.617 ft, Weight: 1.4 kg approx.	onnector outer diameter: Ø14.7 mm Ø0.579 in max.		
		HL-C2CCJ30	Length: 30 m 98.425 ft, Weight: 2.0 kg approx.				

FIBER SENSORS

LASER SENSORS

SPECIFICATIONS

Sensor heads

0-	\swarrow	Туре	Small beam spot type							
	Item Model No.		HL-C201F(E) HL-C203F(E)			HL-C2	11F(E)	HL-C21	11F5(E)	
	Setu	o mode	Specular reflective	Diffuse reflective	Specular reflective	Diffuse reflective	Specular reflective	Diffuse reflective	Specular reflective	
	Meas	surement center distance	10 mm 0.394 in	30 mm 1.181 in	26.4 mm 1.039 in	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	
sN	Meas	suring range (Note 3)	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	
F F [/ // (Reso Aver Note	lution rage number of samples] e 4)	0.04 μm 0.0016 mil [256] 0.01 μm 0.0004 mil [4,096] (HL-C201FE : 0.25 μm 0.010 mil [256])	0.1 μm 0.0 0.025 μm 0.0 (HL-C203FE : 0.25	0.1 μm 0.004 mil [256] 0.25 μm 0.001 mil [4,096] HL-C203FE: 0.25 μm 0.010 mil [256]) (HL-C211FE and HL-C211F5E: 0.25 μm 0.				10 mil [256])	
L	Linea	arity (Note 5)	±0.02 % F.S.			±0.03	% F.S.			
Г	Temp	prerature characteristics			0.01 %	F.S./°C				
			Red	semiconductor	laser (Peak emi	ssion wavelengt	h: 658 nm <mark>0.026</mark>	mil)		
· L	Light source		Class 1 (IEC / JIS / FDA, Laser Notice No.50), Max. output: 0.1 mW	(Class 2 (IEC / JI Max. outp	EC / JIS), Class II (FDA) ax. output: 1 mW		Class 3R (IEC / JIS), Class Illa (FDA) Max. output: 5 mW		
E	Bean	n size (Note 6)	ø20 µm ø0.787 mil approx.	ø30 µm ø1.18	81 mil approx.	nil approx. Ø80 µm ø3.150 mil approx.				
F	Rece	iving element	Linear image sensor							
	Laser emission Laser emission Measuring range		Green LED (lights up during laser emission)							
			Yellow LED (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the measuring range.)							
	e	Pollution degree	3 (Industrial environment)							
	tanc	Protection	IP67 (IEC) (excluding the connector)							
	resis	Ambient temperature	0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F							
	intal	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH							
	nme	Ambient illuminance	Incandescent light: 3,000 & at the light-receiving face							
	nvirc	Vibration resistance	10 to 55 Hz (period: 1 min.) frequency, 1.5 mm 0.059 in amplitude in X,Y and Z directions for two hours each							
	шſ	Shock resistance	196 m/s	² acceleration (2	0 G approx.) in 2	X,Y and Z direct	ions for three tim	nes each		
C	Cable	e		Cabtyre	cable, 0.5 m 1.6	40 ft long with c	onnector			
C	Cable extension		E	extension up to to	otal 30 m 98.425	ft is possible, w	ith optional cable	e.		
Ν	Vate	rial	Enclosur	e: Die-cast alum	ninum, Case cove	er: Die-cast alun	ninum, Front cov	er: Glass		
٧	Weig	ht	250 g approx. (including cable)			300 g approx. (including cable)		
A	Acce	ssory	English warning label: 1 set [The FDA	regulations conform	ing type includes a s	et of both the IEC la	bel (written in Englis	h) and JIS label (wri	tten in Japanese)].	
Notes: 1) HL-C201F, HL-C203F, HL-C211F5, HL-C211F5 fall under the Japanese Export Control. These products are introduced to limited countries only.										

Notes: 1) HL-C201F, HL-C201F, HL-C211F, HL-C211F5 fall under the Japanese Export Control. These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE'

2) Where measurement conditions have not been specified precisely, the conditions used were as follows: supply voltage 24 V DC, ambient temperature +20 °C +68 °F, sampling rate 40 µs, average number of samples: 256, object measured at measurement center distance is made of white ceramic [an aluminum vapor deposition surface reflection mirror was used HL-C201F(E)] and digital measurement values. 3)

-											
N	leasuring	range a	at sam	pling	periods	of 20	µs and	10	µs is	as follows	s.

Model N	lo.	HL-C201F(E)	HL-C2	03F(E)	HL-C211F(E), HL-C211F5(E)		
Setup mode Specular reflective		Diffuse reflective Specular reflective		Diffuse reflective	Specular reflective		
Sampling	20 μs +0.1 to +1.0 mm +0.004 to +0.039 in		0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	
	10 µs	+0.8 to +1.0 mm +0.032 to +0.039 in	+3.8 to +5.0 mm +0.150 to +0.197 in	+3.6 to +4.6 mm +0.142 to +0.181 in	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	

4) The P-P value for the deviation in the digital measurement values at the measurement center range has been converted for the measurement center distance.

5) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.

6) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

Selection Guide

HL-G1

SPECIFICATIONS

Sensor heads

ItemModel No.HL-C201F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKHL-C21F(E)-MKJITURE reflectiveSpecular reflectiveSpe	1F5(E)-MK /e Specular reflective in 106.7 mm 4.201 in in ±14.5 mm ±0.571 in m 0.010 mil [256])
Setup modeSpecular reflectiveSpecular reflectiveSpecular reflectiveSpecular reflectiveSpecular reflectiveSpecular reflectiveSpecular reflectiveSpecular reflectiveDiffuse reflectiveSpecular reflectiveSpecular reflectiveDiffuse reflectiveSpecular reflective	ve Specular reflective in 106.7 mm 4.201 in in ±14.5 mm ±0.571 in im 0.010 mil [256])
$ \begin{array}{ c c c c c } \hline \begin{tabular}{ c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	in 106.7 mm 4.201 in in ±14.5 mm ±0.571 in im 0.010 mil [256])
$ \begin{array}{ c c c c c } \hline \mbox{Measuring range (Note 3)} & \pm 1 \mbox{ mt } \pm 0.039 \mbox{ in } \pm 5 \mbox{ mt } \pm 0.197 \mbox{ in } \pm 46 \mbox{ mt } \pm 0.181 \mbox{ mt } \pm 15 \mbox{ mt } \pm 0.571 \mbox{ mt } \pm 15 \mbox{ mt } \pm 0.571 \mbox{ mt } 0.571 \mbox{ mt } \pm 0.571 \mbox{ mt } 0$	in ±14.5 mm ±0.571 in im 0.010 mil [256])
Resolution [Average number of samples] (Note 4) 0.04 µm 0.0016 mil [256] 0.01 µm 0.0004 mil [4,096] (HL-203FE-MK: 0.25 µm 0.010 mil [256]) 0.1 µm 0.004 mil [256] 0.025 µm 0.001 mil [256]) 0.4 µm 0.016 mil [256] 0.1 µm 0.004 mil [4,096] (HL-2211FE-MK and HL-C211FE-MK and HL-C211FE-MK: 0.25 µm 0.010 mil [250]) Linearity (Note 5) ±0.02 % F.S. ±0.03 % F.S.'C Termy reature characteristics 0.01 % F.S.'C 0.01 % F.S.'C Linearity (Note 6) [Class 1 [CC / JIS / FDA, Laser Notice No.50), Max. output: 0.1 mW Class 2 (IEC / JIS), Class II (FDA) Max. output: 1 mW Class 3R (IEC / Max. output: 0.1 mW Bearts ize (Note 6) 20 × 700 µm 0.787 × 27.559 mil approx. 30 × 1,200 µm 1.181 × 47.244 mil approx. 80 × 1,700 µm 3.150 × 66.929 mil approx. 66.929 mil approx. Negarity approx Laser emission Green LED (lights up during laser emission) Yellow LED Vellow LED (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 3 (Industrial environment) 3 (Industrial environment) Protection Protection 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	ım 0.010 mil [256])
Line±0.02 % F.S.±0.02 % F.S.±0.03 % F.S.Image: Image:	
Tempretature characteristics 0.01 % F.S./°C Light source Red semiconductor laser (Peak emission wavelength: 658 nm 0.026 mil) Light source Class 1 (EC / JIS / FDA, Laser Notice No.50), Max. output: 0.1 mW Class 2 (IEC / JIS), Class II (FDA) Max. output: 1 mW Class 3R (IEC / Max. output: 0.1 mW Bearsize (Note 6) 20 × 700 µm 0.787 × 27.559 mil approx. 30 × 1,200 µm 1.181 × 47.244 mil approx. 80 × 1,700 µm 3.150 × 66.929 mil approx. Recersing element Linear image sensor Linear image sensor 1 Laser emission Green LED (lights up during laser emission) Yellow LED Yellow LED (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 20 (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 20 (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 20 (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 20 (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 20 (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 20 (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 20 (lights up when near the measurement center distance, blinks when wi	
Red semiconductor laser (Peak emission wavelength: 658 nm 0.026 mll) Light source Class 1 (EC / JIS / FDA, Laser Notice No.50), Max. output: 0.1 mW Class 2 (IEC / JIS), Class II (FDA) Max. output: 1 mW Class 3R (IEC / Max. output: 1 mW Be Image: Semiconductor laser (Note 6) 20 × 700 µm 0.787 × 27.559 mil approx. 30 × 1,200 µm 1.181 × 47.244 mil approx. 80 × 1,700 µm 3.150 × 66.929 mil approx. Receive gelement Linear image sensor Yellow LED (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the gelement Pollution degree Pollution degree 3 (Industrial environment) Pollution degree 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	
Light source Class 1 (IEC / JIS / FDA, Laser Notice No.50), Max. output: 0.1 mW Class 2 (IEC / JIS), Class II (FDA) Max. output: 1 mW Class 3R (IEC / MAX. output: 1 Max. output: 1 mW Be 20 × 700 µm 0.787 × 27.559 mil approx. 30 × 1,200 µm 1.181 × 47.244 mil approx. 80 × 1,700 µm 3.150 × 66.929 mil approx. Receive gelement 20 × 700 µm 0.787 × 27.559 mil approx. 30 × 1,200 µm 1.181 × 47.244 mil approx. 80 × 1,700 µm 3.150 × 66.929 mil approx. Receive gelement Laser emission Sensor Sensor Vellow LeD (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the Receive gelement Yellow LED Pollution degree 9 cluton degree 3 (Industrial environment) Protection 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	
Beam size (Note 6) 20 × 700 µm 0.787 × 27.559 mil approx. 30 × 1,200 µm 1.181 × 47.244 mil approx. 80 × 1,700 µm 3.150 × 66.929 mil a Receiving element Linear image sensor Laser emission Yellow LED (lights up during laser emission) Measuring range (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the 9 Pollution degree 3 (Industrial environment) Protection IP67 (IEC) (excluding the connector) Ambient temperature 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	JIS), Class Illa (FDA) Jtput: 5 mW
Receiving element Linear image sensor Image sensor Image sensor Image sensor Green LED (lights up during laser emission) Yellow LED Yellow LED Image sensor Yellow LED Yellow LED (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the sensor Pollution degree 3 (Industrial environment) Protection IP67 (IEC) (excluding the connector) Ambient temperature 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	approx.
Laser emission Green LED (lights up during laser emission) Measuring range Yellow LED Pollution degree (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the Pollution degree 3 (Industrial environment) Protection IP67 (IEC) (excluding the connector) Ambient temperature 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	
Yellow LED Measuring range Yellow LED (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the Pollution degree 3 (Industrial environment) Protection IP67 (IEC) (excluding the connector) Ambient temperature 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	
Pollution degree 3 (Industrial environment) Protection IP67 (IEC) (excluding the connector) Ambient temperature 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	e measuring range.)
Option IP67 (IEC) (excluding the connector) Ambient temperature 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	
Ambient temperature 0 to +45 °C +32 to +113 °F (No dew condensation), Storage: -20 to +70 °C -4 to +158 °F	
The second sec	
Ambient illuminance Incandescent light: 3,000 tx at the light-receiving face	
Vibration resistance 10 to 55 Hz (period: 1 min.) frequency, 1.5 mm 0.059 in amplitude in X,Y and Z directions for two hou	urs each
W Shock resistance 196 m/s² acceleration (20 G approx.) in X,Y and Z directions for three times each	
Cable Cabtyre cable, 0.5 m 1.640 ft long with connector	
Cable extension Extension up to total 30 m 98.425 ft is possible, with optional cable.	
Material Enclosure: Die-cast aluminum, Case cover: Die-cast aluminum, Front cover: Glass	
Weight 250 g approx. (including cable) 300 g approx. (including cable)	
Accessory English warning label: 1 set [The FDA regulations conforming type includes a set of both the IEC label (written in English) and JIS label (v	

Notes: 1) HL-C201F-MK, HL-C203F-MK, HL-C211F-MK, HL-C211F5-MK fall under the Japanese Export Control. These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE'.

2) Where measurement conditions have not been specified precisely, the conditions used were as follows: supply voltage 24 V DC, ambient temperature +20 °C +68 °F, sampling rate 40 µs, average number of samples: 256, object measured at measurement center distance is made of white ceramic [an aluminum vapor deposition surface reflection mirror was used HL-C201F(E)-MK] and digital measurement values.

3) Measuring range at sampling periods of 20 μs and 10 μs is as follows.

		01					
Model N	o.	HL-C201F(E)-MK	HL-C203	BF(E)-MK	HL-C211F(E)-MK, HL-C211F5(E)-M		
Setup mo	p mode Specular reflective Diffuse reflective Specular reflect		Specular reflective	Diffuse reflective	Specular reflective		
Sampling	20 µs +0.1 to +1.0 mm +0.004 to +0.039 in		0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	
	10 µs	+0.8 to +1.0 mm +0.032 to +0.039 in	+3.8 to +5.0 mm +0.150 to +0.197 in	+3.6 to +4.6 mm +0.142 to +0.181 in	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	

4) The P-P value for the deviation in the digital measurement values at the measurement center range has been converted for the measurement center distance.

5) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.

6) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.

FIBER SENSORS

LASER SENSORS

Selection Guide Laser Displacement Magnetic Displacement Collimated Beam Digital Panel Controller Metal-speet Detection



SPECIFICATIONS

Controllers

LASER SENSORS	Сог	ontrollers				
PHOTO-	\bigvee	Туре	NPN output type	PNP output type		
SENSORS	Item	Model No.	HL-C2C(E)	HL-C2C(E)-P		
ELECTRIC SENSORS	Connectale sensor head		Number of connectable units: Max. 2 units.			
AREA SENSORS	Supply voltage		24 V DC ±10 % including ripple 0.5 V (P-P)			
LIGHT CURTAINS	Current consumption		500 mA approx. at 2 sensor heads connected 350 mA approx. at 1 sensor head connected (100 mA approx. is additionally required when the mini console is connected)			
PRESSURE / FLOW	Sam	pling cycle	10 μs, 20 μs, 40 μs, 100 μs, 200 μs, 400 μs, 1 ms, 2 ms			
SENSORS INDUCTIVE PROXIMITY SENSORS PARTICULAR USE SENSORS	output	Voltage (Note 2)	Voltage output scale: –5 to +5 V/F.S (initial value) Output range during normal status: –10.0 to +10.0 V Output at abnormal status: –10.8 V or +10.8 V Resolution: 2 mV, Linearity: ±0.05 % F.S. Max. 2 mA, output impedance 50 Ω, Response delay time: 1.5 µs/V approx.			
SENSOR OPTIONS SIMPLE WIRE-SAVING UNITS	Analog	Current (Note 3)	Current output scale: 4 to 20 mA/F.S (initial value) Output range during normal status: 2 to 24 mA Output at abnormal status: 1 mA or 25 mA Resolution: 3 μA, Linearity ±0.05% F.S. Load impedance: 250 Ωmax., Response delay time: 10 μs approx.			
WIRE-SAVING SYSTEMS MEASURE- MENT SENSORS STATIC CONTROL	Alar	m output	NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between alarm output and Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)	 PNP open-collector transistor Maximum source current: 100 mA Applied voltage: 30 V DC or less (between alarm output and +V) Residual voltage: 1 V or less (at 100 mA source current) 		
DEVICES		Output operation	Opened when the amou	unt of light is insufficient		
ENDOSCOPE		Short-circuit protection	Incorp	orated		
LASER MARKERS PLC / TERMINALS HUMAN	Judo (HI,	gment output GO, LO)	NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between judgment output to Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)	 PNP open-collector transistor Maximum source current: 100 mA Applied voltage: 30 V DC or less (between judgment output to +V) Residual voltage: 1 V or less (at 100 mA source current) 		
MACHINE INTERFACES		Output operation	Opened at output operation			
ENERGY CONSUMPTION VISUALIZATION		Short-circuit protection	Incorporated			
COMPONENTS FA COMPONENTS MACHINE VISION SYSTEMS UV CURING	Stro	be output	NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between strobe output to Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)	PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between strobe output to +V) • Residual voltage: 1 V or less (at 100 mA source current)		
SYSTEMS		Short circuit protection	Opened at data determination			
Selection Guide Laser Displacement	Rem	note interlock input	Laser emission is delayed when connected to Common (–). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)	Laser emission is delayed when connected to IL (+). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)		
Magnetic Displacement Collimated Beam Digital Panel Controller	Lase	er control input	Laser emission is stopped when connected to Common (–). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)	Laser emission is stopped when connected to external power (+). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)		
Metal-sheet Double-feed Detection HL-G1	Zero	o set input	Zero set is ON when connected with Common (–). Zero set turns to OFF after continuously connected to Common (–) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)	Zero set is ON when connected with external power (+). Zero set turns to OFF after continuously connected to external power (+) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)		
HL-C2 HL-C1 LM10	Timi	ing input	ON at/during connection to Common (–) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)	ON at/during connection to external power (+) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)		
	Res	et input	Reset is done when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)	Reset is done when connected to external power (+). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)		
	Men	nory change input	Memory is specified when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)	Memory is specified when connected to external power (+). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)		

SPECIFICATIONS

Controllers

Соі	ntrollers			LASER SENSORS	
\swarrow	Туре	NPN output type	PNP output type	PHOTO-	
Item	n Model No.	HL-C2C(E)	HL-C2C(E)-P	SENSORS	
Power		Green LED (lights	s up at power on)	PHOTO- ELECTRIC SENSORS	
Sensor head A Laser radiation		Green LED (lights up during or immediatel	Green LED (lights up during or immediately before laser emission of sensor head A)		
dicator	Sensor head B Laser radiation	Green LED (lights up during or immediatel	y before laser emission of sensor head B)		
Ē	Alarm 1	Red LED (lights up when OUT1 can not be r	neasured due to insufficient amount of light)	FLOW SENSORS	
	Alarm 2	Red LED (lights up when OUT2 can not be r	neasured due to insufficient amount of light)	PARTICULAR	
RS-	232C interface	Baud rate: 9,600, 19,200, 38,400, 115,200 bit/s			
USE	interface	USB 2.0 Full-speed (USB 1.1 compatible) compliant			
Sett	ing / data display	Compact cons	sole (optional)	SIMPLE	
ance	Ambient temperature	0 to +50 °C +32 to +122 °F (No dew condensation or	icing allowed), Storage: -20 to +70 °C -4 to +158 °F	UNITS	
Ambient humidity		35 to 8	5 %RH	WIRE-SAVING SYSTEMS	
Vibration resistance		10 to 55 Hz frequency (period: 1 min.), 0.75 mm 0.030	in amplitude in X, Y and Z directions for 30 min. each	MEASURE-	
Shock resistance		196 m/s ² acceleration (20G approx.) in X	, Y, and Z directions for three times each	SENSORS	
Material		Case: Polycarbonate			
Wei	ght	450 g a	approx.	ENDOSCODE	
Accessories		CD-ROM: 1 pc., USB cable (2 m 6.562 ft long); 1 pc., Short bracket: 1 pc.			

Notes: 1) HL-C2C and HL-C2C-P fall under the Japanese Export Control. These products are introduced to limited countries only. Please refer to **'PRECAUTIONS FOR PROPER USE'**

2) The linearity is F.S.=20 V to digital measurement value. Response delay time is the period after update of measurement value.

3) The linearity is F.S.=16 mA to digital measurement value. Response delay time is the period after update of measurement value.

Compact console

	Туре	English display	Japanese display	Chinese display	Korean display	ENERGY CONSUMPTION VISUALIZATION	
Item Model No.		HL-C2DP-EX	HL-C2DP	HL-C2DP-CH	HL-C2DP-KR		
Power			Supplied by controller				
Display element		STN monochrome LCD					
lay	Back light		White	ELED			
Disp	Display range		-999.999999 to 999.999999				
	Language	English	Japanese	Chinese	Korean	_	
panel	Operational force		0.5 N	or less			
Touch	Lifetime		1,000,000 times	or more (Note 1)		Selection Guide	
ance	Environment resistance	Dust prevention and o	IP65 (at initial s drip-proof at the front panel (wate	status) (Note 2) erproof packing is used at the co	ntact surface to board)	Laser Displacement Magnetic Displacement	
esista	Ambient temperature	0 to +50 °C +32 to +122 °F (No dew condensation or icing allowed), Storage: -20 to +60 °C -4 to +140 °F					
ital re	Ambient humidity		20 to 85 %RH, Stor	age: 10 to 85 %RH		Digital Panel Controller	
mer	Electrostatic noise resistance	5,000 V or more (panel surface)					
viror	Vibration resistance	10 to 55 Hz frequency, 0.75 mm 0.030 in amplitude in X, Y and Z directions for 10 min. each					
Ш	Shock resistance	98 m/s² or	more acceleration (10G approx.)	in X, Y and Z directions for four	times each	HL-G1	
Mate	erial		Case: PPE, Front prot	ective sheet: Polyester		HL-C2	
Weight		230 g approx.			HL-C1		
Accessories		Connector cable for connecting the controller to the console : 1 pc., Mounting bracket: 1 set			LM10		

Notes: 1) This value indicates the average lifetime of the unit when used under a normal temperature of +25 °C +77 °F.

2) When reinstalling the console, replace the water proof packing. (Part No: AIGT181, 10 packs included)

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FIBER SENSORS

LASER MARKERS

PLC / TERMINALS

HUMAN MACHINE INTERFACES

LASER SENSORS

I/O CIRCUIT AND WIRING DIAGRAMS (CONTROLLERS)

NPN output type





Controller internal circuit --- Extemal connection example



Selection Guide Magnetic Displacement Collimated Beam Digital Panel Controller Metal-shee Double-feed Detection

UV CURING SYSTEMS



LM10

Analog output (Common in NPN output type and PNP output type)

Non-voltage input

Common(−) ↔

IL∽

NPN open-collector transistor output

IN↔

Common(-)o

Non-voltage input

IN≎-

Common(-)o

0



Controller internal circuit -External connection example

Notes: 1) Do not short-circuit analog output terminals or apply voltage to them. 2) Use shielded wires for analog outputs.

PNP output type

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

LIGHT CURTAINS

PRESSURE FLOW SENSORS

INDUCTIVE PROXIMITY SENSORS

PARTICULAR USE SENSORS

SENSOR OPTIONS

SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS

STATIC CONTROL DEVICES

ENDOSCOPE

LASER MARKERS

PLC / TERMINALS

HUMAN MACHINE INTERFACES

ENERGY CONSUMPTION

VISUALIZATION COMPONENTS

I/O CIRCUIT AND WIRING DIAGRAMS (CONTROLLERS)

Terminal arrangement

Terminal block 1 Terminal block 2 Õ

Terminal block 3

Terminal block 1 Terminal Function NPN PNP (V)1 Analog voltage output (for OUT1) AGND Analog ground (I)1 Analog current output (for OUT1) (V)2 Analog voltage output (for OUT2) AGND Analog ground Analog current output (for OUT2) (I)2 Laser control input (for Head A) I SRA Laser stop during short circuit Laser control input (for Head B) LSRB Laser stop during short circuit (-) Common (-) IL IL-Remote interlock Laser stop when opened. (-) IL+ Remote interlock common

Terminal block 2		
Function		
		Zero set input (for OUT2) ON during short circuit (Note 1)
Timing input (for OUT2) ON during short circuit		
Reset input (for OUT2) ON during short circuit		
Common (–)		
Alarm output (for OUT2)		
Strobe output (for OUT2)		
Judgment HI output (for OUT2)		
Judgment GO output (for OUT2)		
Judgment LO output (for OUT2)		
Reserved terminal (Note 2)		
Common (–) / Common (+)		
Memory change (16 ways)		
		Common (–)

Torminal block 2

Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

2) Do not connect anything to the reserved terminals; they are connected to the internal circuit.

Terminal		Function	
NPN PNP			
ZS1		Zero set input (for OUT1) ON during short circuit (Note 1)	
TN	И1	Timing input (for OUT1) ON during short circuit	
R	S1	Reset input (for OUT1) ON during short circuit	
	•	Reserved terminal	
	•	Reserved terminal	
(-	-)	Common (–)	
AI	L1	Alarm output (for OUT1)	
S	T1	Strobe output (for OUT1)	
Н	11	Judgment HI output (for OUT1)	
G	D1	Judgment GO output (for OUT1)	
LC	D1	Judgment LO output (for OUT1)	
•		Reserved terminal (Note 2)	
(-) (+)		Common (–) / Common (+)	
24V		24 V DC input for power supply	
0V		Power supply ground 0 V	
FG		Frame ground	
Notes: 1)		Turn off the terminal in case	

Terminal block 3

Ter

NP

(-) 2

|

Not

one second. 2) Do not connect anything to the

reserved terminals; they are connected to the internal circuit.

FA COMPONENTS MACHINE VISION SYSTEMS UV CURING SYSTEMS

SENSING CHARACTERISTICS (TYPICAL)

HL-C201F(E)

Correlation between measuring distance and error characteristics

Setup mode: Specular reflective

Aluminum vapor deposition surface reflection mirror (0°, ±0.5°) Vertical orientation



Aluminum vapor deposition surface reflection mirror (0°, ±0.2°) Horizontal orie ntation







Selectio Guide Magnetic Displaceme Collimated Beam Digital Pane Controller Metal-sheet Double-feed Detection 11.0 HL-G1 HL-C2



10.5

SENSING CHARACTERISTICS (TYPICAL)

HL-C203F(E)



Be sure to read instruction manual attached to the product prior to its use.



 For CE marking compliance, a sensor head, controller and console with the '€€' mark attached must be used together. Check that the ' \in ' mark is attached to each device to be connected.

for personnel protection.



 In case of using sensing devices for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

PRECAUTIONS FOR PROPER USE



· Below mentioned products fall under Japanese Export Control, which is defined by "Foreign Exchange and Foreign Trade Act". Therefore, anyone who wishes to export or transfer these products outside of Japan is required to obtain the necessary license from the Ministry of Economy, Trade and Industry of Japan. Also, these products fall under international export control regulations, such as Nuclear Suppliers Group (NSG)

guidelines 1.B.3.b.1 and Wassenaar Arrangement (WA) 2.B.6.b.1.a, and are objects of the regulation. Please comply with the export control in each country.

Products subject to control

- Sensor head: HL-C201F. HL-C201F-MK. HL-C203F, HL-C203F-MK, HL-C211F, HL-C211F-MK, HL-C211F5, HL-C211F5-MK
- Controller: HL-C2C, HL-C2C-P
- Note: These products are introduced to limited countries only. Please contact our office for details.



HL-C211F(E)

Measurement center distance

Measuring range

Small beam spot type

0.2

≍0.08

0.2

0.ź4

0.08

0.24 ×



Refer to General precautions and About laser beam.

HL-C203F(E)-MK Linear beam spot type



HL-C211F(E)-MK Linear beam spot type





0.03

0.00

0.18

0.2

0.08

0.2

Guide
Laser Displacement
Magnetic Displacement
Collimated Beam
Digital Panel Controller
Metal-sheet Double-feed Detection

HL-G1 HL-C2 HL-C1 LM10

LASER SENSORS PHOTO-ELECTRIC SENSORS MICRO PHOTO-ELECTRIC SENSORS AREA SENSORS LIGHT PRESSURE / FLOW SENSORS INDUCTIVE PROXIMITY SENSORS PARTICULAR USE SENSOR OPTIONS SIMPLE WIRE-SAVING UNITS WIRE-SAVING SYSTEMS STATIC CONTROL ENDOSCOPE LASER MARKERS PLC / TERMINALS HUMAN MACHINE INTERFACES ENERGY VISUALIZATION COMPONENTS COMPONENTS MACHINE VISION UV CURING SYSTEMS

Selection Guide

Magne

Collimate Bean

Digital Pane Controlle

Metal-shee Double-feed Detection

HL-G1

HL-C2

HL-C1

LM10

PRECAUTIONS FOR PROPER USE

Mutual interference

- When installing two or more sensor heads side by side, mutual interference will not occur if the laser spots from other sensor heads do not fall within the shaded areas of the sensor head in the figure below.
- When connecting two sensor heads to one controller, the mutual interference prevention function can be used. Therefore the measures shown below are not necessary.

HL-C203F



HL-C211F



Refer to General precautions and About laser beam.

Sensor head mounting direction

• To obtain the greatest precision, the sensor head should be oriented facing the direction of movement of the object's surface, as shown in the figure below.

Object with variations in material or color



Rotating object

(Unit: mm in)





Object that has large differences in gaps, grooves and colors



Safety standards for laser beam products

 A laser beam can harm human being's eyes, skin, etc., because of its high energy density. IEC has classified laser products according to the degree of hazard and the stipulated safety requirements. The HL-C2 series is classified as Class 1 / Class 2 / Class 3R laser. (Refer to About laser beam.)

Safe use of laser products

 For the purpose of preventing users from suffering injuries by laser products, IEC 60825-1(Safety of laser products). Kindly check the standards before use. (Refer to About laser beam.)

Controller

Description

POWER

indicator

indicator

indicator

ALM1 (Alarm)

ALM2 (Alarm)

LASER A indicator

LASER B indicator

1

2

3

4

5

6

7

8

9

10

(1)

(12)

(13)

(14)

(15)

(16)

PRECAUTIONS FOR PROPER USE

Fuctional description

Sensor head



\searrow	Description	Function
1	Laser emission indicator (Green LED)	Lights up during laser emission.
2	Measurement range indicator (Yellow LED)	Lights up when the target reaches at approximately center of the measurement. Blinks when the target enters within the measurement range. Turns off the light when the target goes out of the measurement range.
3	Light emitter	Emits the laser light.
4	Light receiver	Receives the laser specular light from a measurement target.
5	Warning label	Shows the laser emission position. Please read carefully before use.

controller.

Refer to General precautions and About laser beam.

Function

Lights up in green when electricity is provided to the

Lights up in red during dark status (poor light intensity)

of OUT1 or the sensor head is in unconnected status.

Lights up in red during dark status (poor light intensity)

of OUT2 or the sensor head is in unconnected status.

Lights up in green during the laser radiation of Head A.

Lights up in green during the laser radiation of Head B.

Abnormal condition indicator for OUT1.

Abnormal condition indicator for OUT2.

am.	FIBER SENSORS
	LASER SENSORS
	PHOTO- ELECTRIC SENSORS
	MICRO PHOTO- ELECTRIC SENSORS
	AREA SENSORS
	LIGHT CURTAINS
	PRESSURE / FLOW SENSORS

INDUCTIVE PROXIMITY SENSORS PARTICULAR USE SENSORS

SENSOR OPTIONS SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS

STATIC CONTROL DEVICES ENDOSCOPE

LASER MARKERS PLC / TERMINALS

iuman Machine Nterfaces NERGY ONSUMPTION ISUALIZATION OMPONENTS

COMPONENTS MACHINE /ISION SYSTEMS JV CURING SYSTEMS

> electio Guide agnetic isplacem ollimated eam gital Pane ontroller letal-sheet ouble-feed etection

HL-G1 HL-C2 HL-C1 LM10

Analog output terminal	Terminal for analog data output.
Laser control terminal	Stops laser emission in case of short-circuiting.
Remote interlock terminal	Stops laser emission when its opened.
USB connector	Used for communication with PC using USB.
Console connection connector	Used for connecting the mini console.
RS-232C connector	Used for communication with the control devices using RS-232C.
I/O terminal	Terminal for various I/O (Zero set input, Timing input, Reset input, Alarm output, Strobe output, and Judgment output) and memory change.
Power terminal	Terminal for power supply to the controller.
Sensor head A connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head A" and starts operation.
Sensor head B connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head B" and starts operation.
DIN rail mounting hook	Used for hooking/removing the sensor heads to/from the 35mm width DIN rail with one-touch simple operation.

Note: In case of connecting one sensor head to the controller, be sure to connect the sensor head to (1) the sensor head A connection (HEAD A) side. If the sensor head is connected to (15) the sensor head B connection (HEAD B) side, the measurement cannot be performed.

DIMENSIONS (Unit: mm in)



HL-C201F(E) HL-C201F(E)-MK

Set mode: Specular reflective type



HL-C203F(E) HL-C203F(E)-MK

Set mode: Diffuse reflective type



Set mode: Specular reflective type



HL-C211FD(E) HL-C211FD(E)-MK

Selection Guide Lase Displacement Displacement Collimated Beam Digital Panel Controller Metal-sheet Double-feed Detection

HL-G1 HL-C2 HL-C1 LM10

Set mode: Diffuse reflective type



Set mode: Specular reflective type



Sensor head

Sensor head

Sensor head

